

# **LGAD Tracking and Timing Layers improved detector design**

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**ECCE Tracking Meeting  
August 13, 2021**

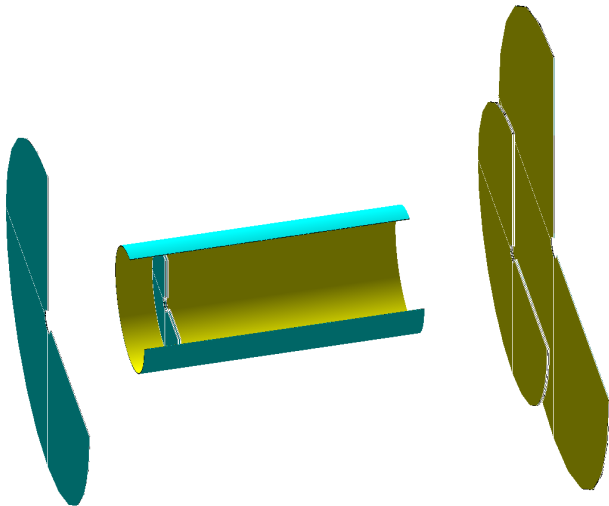
**Nicolas Schmidt**



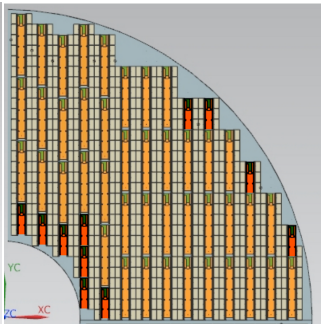
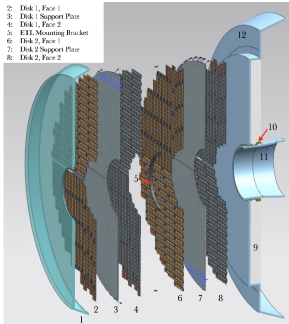
# Previous TTL layer setup

## Design:

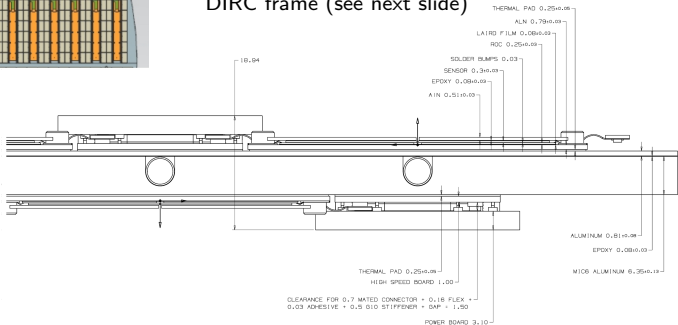
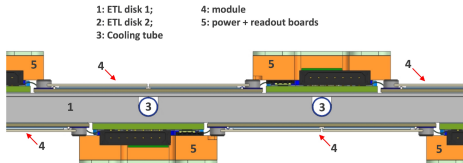
- barrel: basic cylinder layers
- forward/backward: basic disk layers
- no supports or readout
- underestimated material budget  
→  $85\mu\text{m}$  silicon,  $100\mu\text{m}$  Al,  $20\mu\text{m}$  Kapton,  
 $100\mu\text{m}$  water,  $50\mu\text{m}$  graphite, 1cm air,  $50\mu\text{m}$  graphite
- homogeneously distributed silicon layer considered as active material



# Basic design update principles

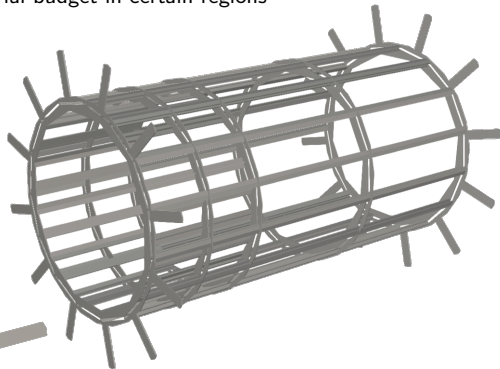
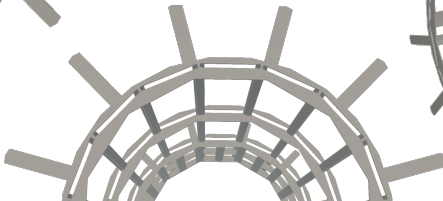
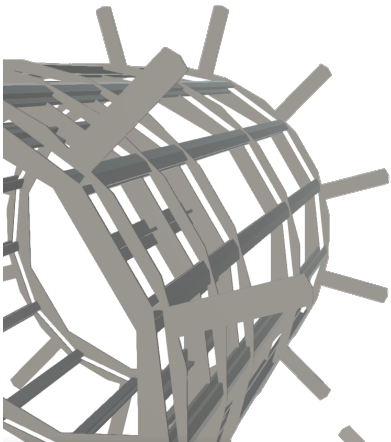


- Design based on the CMS forward upgrade [link]
- Basic elements: ladders of 3 or 6 LGAD sensors with service hybrid (for readout and power)
- Sensors mounted on aluminum plate (currently 6mm thick) and contains cooling
- Sensors on back side of plate shifted to cover service hybrid dead area (see bottom figure)
- Barrel layer to be mounted on inner or outer part of DIRC frame (see next slide)



# DIRC frame in barrel

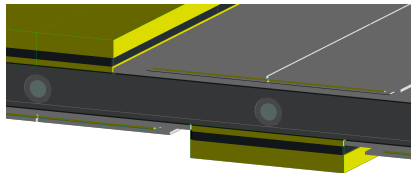
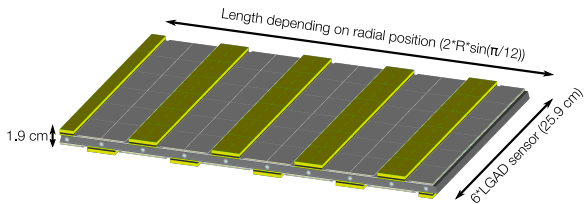
- Currently only stepping files of this frame exist (sent around by Tanja)  
→ porting to Fun4All needed
- Frame allows to mount modules on various radial positions
- Considered material is steel at the moment  
→ significant material budget in certain regions



# New Layers in Geant4

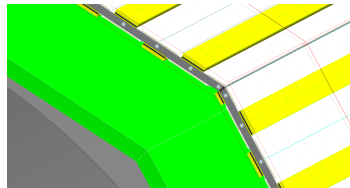
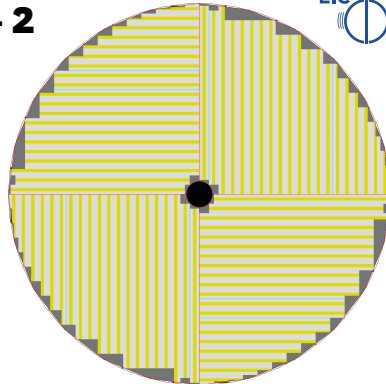
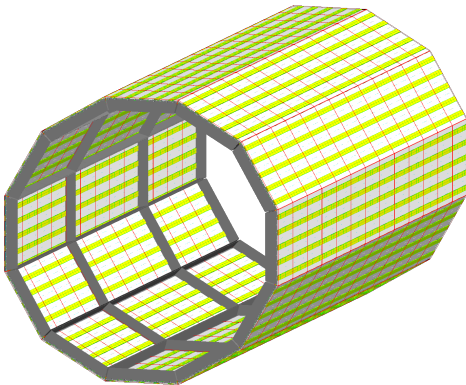
`fun4all_eicdetectors/simulation/g4simulation/g4ttl`

- LGAD sensors ( $21 \times 42\text{mm}^2$ ) mounted on readout chips ( $21 \times 21\text{mm}^2$ ) on top of Aluminum Nitride substrate for thermal conduction to aluminum plate
- Al plate in total 7.16mm thick and contains 5mm diam. cooling tubes
- Service hybrids (big yellow boxes) made of various materials, dominated by the power boards
- Sensors placed on both sides of plate for full coverage (total thickness  $\sim 1.9\text{ cm}$ )
- Each barrel module is 6 LGAD sensors long and width depends on radial position

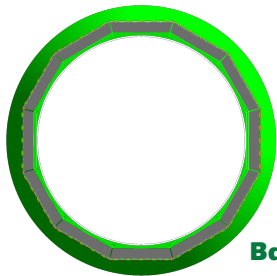


## New Layers in Geant4 - 2

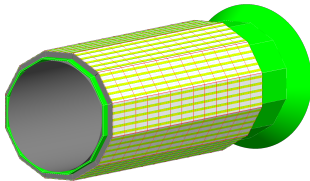
- Barrel made of 12 modules in azimuth and multiple modules along z-axis  
→ implemented additional temporary support structure based on DIRC frame principles (support  $\sim 7$  cm high and 6mm thick)
- Forward layers mounted on identical 1/4 disk slices (→ 4 modules) which are rotated by 90 degrees (see image)



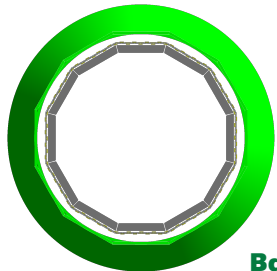
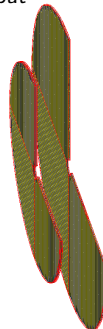
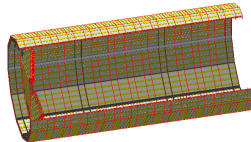
## New Layers in Geant4 - 3



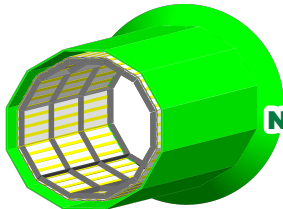
**Barrel layer outside DIRC**



- Implemented barrel radial positions: 50 cm, 80 cm, 89 cm (other radii possible, but not optimized!)
- Forward layers can be at any z position and with any radius



**Barrel layer inside DIRC**



**New TTL layers in default ECCE configuration**

# Summary and next Steps

- New TTL layer geometries implemented
  - barrel allows for all currently required radial positions
  - forward layers are fully flexible in inner and outer radius
- Parts of the detector design could be further improved (e.g. sensor placement on forward layers at high  $\eta$ )
- Material budget is much more realistic now
- Full ECCE tracking soon needs to be transitioned from fast tracking to actual detector-hit based tracking
  - work on digitizer ongoing to have digits (encoded hits in LGADs with x,y,z,t) available
- DIRC frame needs to be ported from CAD file to Fun4All (also requires changes to DIRC itself)